



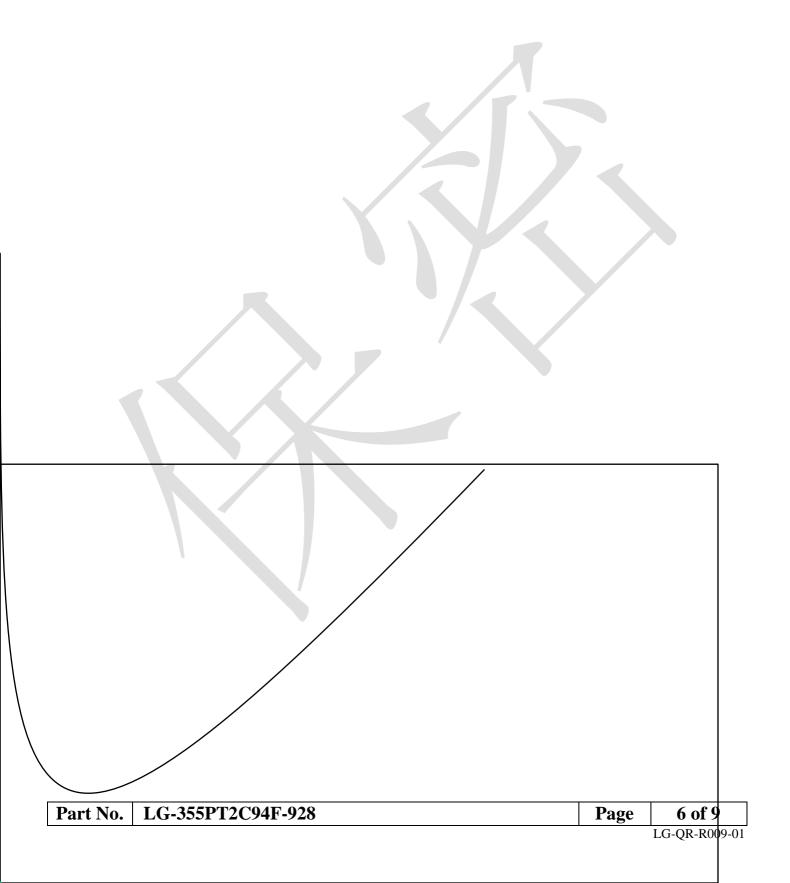


Photo Transistor Diode Specification

- ●Commodity: Photo Transistor
 - ●Ic(on) Bin Code (V_{CE}=5V, Ee=1mW/cm²

BIN CODE	Min. (mA)	Max. (mA)
X2	3.7	4.4
Х3	4.4	5.3

Part No.	LG-355PT2C94F-928	Page	5 of 9
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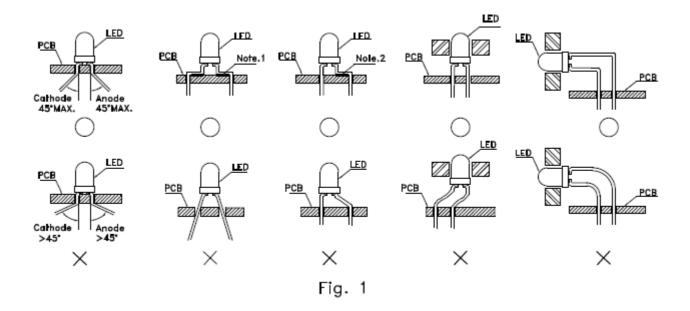






LED MOUNTING METHOD

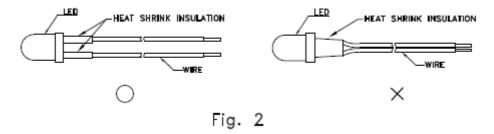
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures (Fig.1).



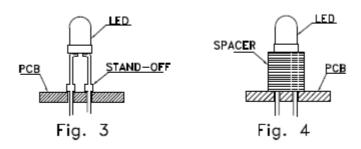
" " Correct mounting method "x" Incorrect mounting method

Note 1-2: Do not route PCB trace in the contact area between the lead frame and the PCB to prevent short-circuits.

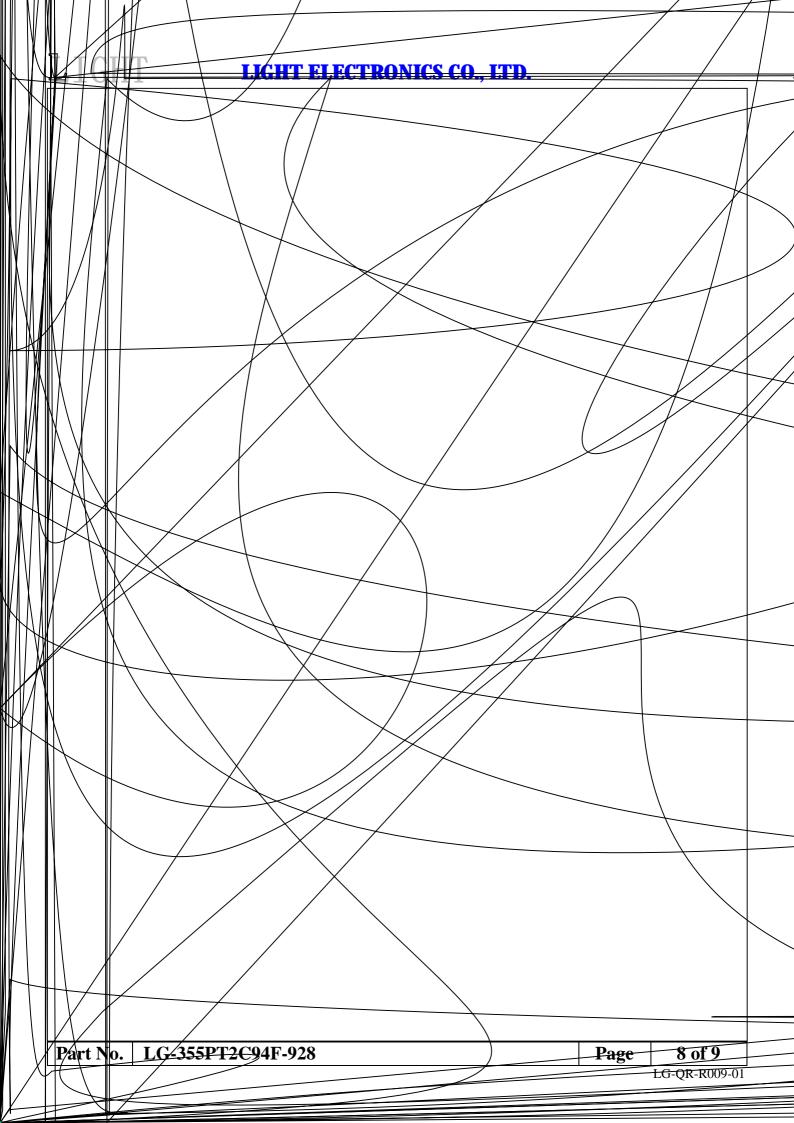
2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit (Fig.2).



3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.

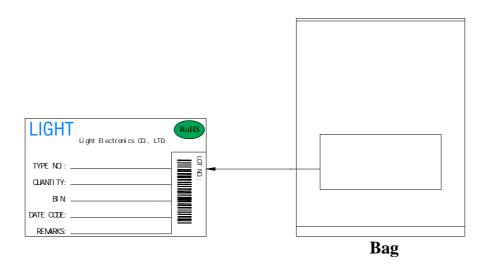


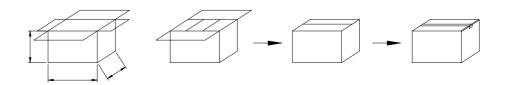
Part No. LG-355PT2C94F-928 Page 7 of 9

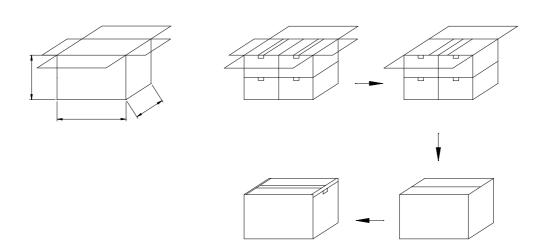




PACKAGE







Bag minimum volume	Bag volume	Inner box volume	Outer carton volume
(pcs / Bag)	(pcs / Bag)	(Bag / box)	(Box / Carton)
500	1000	10	4

Part No.	LG-355PT2C94F-928	Page	9 of 9
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